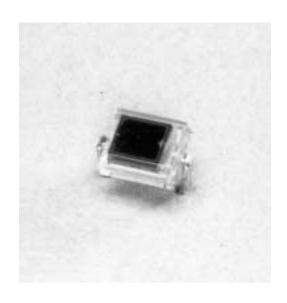
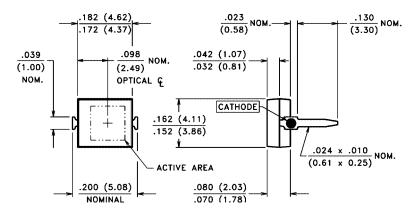
(BPW34 INDUSTRY EQUIVALENT)



PACKAGE DIMENSIONS inch (mm)



CASE 22 MINI DIP CHIP ACTIVE AREA: .012 in² (7.45 mm²)

PRODUCT DESCRIPTION

Planar silicon photodiode in a transparent molded plastic package. Suitable for direct mounting to P.C.B. Arrays can be formed by positioning these devices side by side. These photodiodes are designed to provide excellent sensitivity at low levels of irradiance.

ABSOLUTE MAXIMUM RATINGS

Storage Temperature: -20°C to 80°C
Operating Temperature: -20°C to 80°C

RoHS Compliant



ELECTRO-OPTICAL CHARACTERISTICS @ 25°C

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	VTD34H			LINUTO
			Min.	Тур.	Max.	UNITS
I _{SC}	Short Circuit Current	1000 Lux, 2850 K	50	70		μA
TC I _{SC}	I _{SC} Temperature Coefficient	2850 K		.20		%/°C
V _{OC}	Open Circuit Voltage	H = 1000 Lux, 2850 K	300	365		mV
TC V _{OC}	V _{OC} Temperature Coefficient	2850 K		-2.0		mV/°C
ID	Dark Current	$H = 0$, $V_R = 10 V$		2	30	nA
C_J	Junction Capacitance	@ 1 MHz, V _R = 0 V		60		pF
$t_{\rm p}/t_{\rm F}$	Rise/Fall Time @ 1 kΩ Lead	VR = 10 V, 833 nm		50		nsec
S _R	Sensitivity	@ Peak		0.60		A/W
λ_{range}	Spectral Application Range		400		1100	nm
λ_{p}	Spectral Response - Peak			900		nm
V_{RR}	Breakdown Voltage		40			V
$\theta_{1/2}$	Angular Resp50% Resp. Pt.			±50		Degrees
NEP	Noise Equivalent Power		4.8 x 10 ⁻¹⁴			W/√Hz
D*	Specific Detectivity		5.7 x 10 ¹²			cm√Hz/W

